

# MOS FIELD EFFECT TRANSISTOR $\mu$ PA2755GR

# SWITCHING N-CHANNEL POWER MOS FET

#### **DESCRIPTION**

The  $\mu$  PA2755GR is Dual N-channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

#### **FEATURES**

- Dual chip type
- Low on-state resistance

 $R_{DS(on)1} = 18 \text{ m}\Omega \text{ MAX.} \text{ (VGs} = 10 \text{ V, ID} = 4.0 \text{ A)}$ 

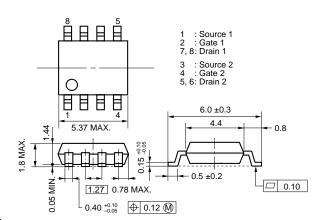
 $R_{\text{DS(on)2}}$  = 29 m $\Omega$  MAX. (Vgs = 4.5 V, Ip = 4.0 A)

- Low Ciss: Ciss = 650 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

#### ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA2755GR	Power SOP8

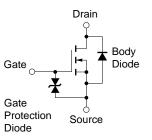
# PACKAGE DRAWING (Unit: mm)



# ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	VDSS	30	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	±8.0	Α
Drain Current (pulse) Note1	ID(pulse)	±32	Α
Total Power Dissipation (1 unit) Note2	P⊤	1.7	W
Total Power Dissipation (2 units) Note2	PT	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note3	las	8	Α
Single Avalanche Energy Note3	Eas	6.4	mJ

# EQUIVALENT CIRCUIT (1/2 circuit)



- **Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%
  - 2. Mounted on ceramic substrate of 2000 mm<sup>2</sup> x 2.2 mm
  - 3. Starting Tch = 25°C, Vdd = 15 V, Rg = 25  $\Omega$ , Vgs = 20  $\rightarrow$  0 V

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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90%

90%

Vgs



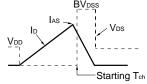
**ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)** 

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			10	μΑ
Gate Leakage Current	Igss	$V_{GS} = \pm 18 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5		2.5	٧
Forward Transfer Admittance Note	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 4.0 A	2.8	5.7		S
Drain to Source On-state Resistance Note	RDS(on)1	Vgs = 10 V, ID = 4.0 A		14	18	mΩ
	RDS(on)2	Vgs = 4.5 V, lp = 4.0 A		21	29	mΩ
Input Capacitance	Ciss	Vps = 10 V		650		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		150		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		98		pF
Turn-on Delay Time	td(on)	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 4.0 A		12		ns
Rise Time	tr	V <sub>G</sub> s = 10 V		16		ns
Turn-off Delay Time	<b>t</b> d(off)	R <sub>G</sub> = 10 Ω		38		ns
Fall Time	t <sub>f</sub>			8.0		ns
Total Gate Charge	Q <sub>G</sub>	VDD = 24 V		13		nC
Gate to Source Charge	Qgs	V <sub>G</sub> S = 10 V		2.2		nC
Gate to Drain Charge	Q <sub>GD</sub>	lo = 8.0 A		3.8		nC
Body Diode Forward Voltage Note	V <sub>F</sub> (S-D)	IF = 8.0 A, VGS = 0 V		0.84		٧
Reverse Recovery Time	trr	IF = 8.0 A, VGS = 0 V		17		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		8.2		nC

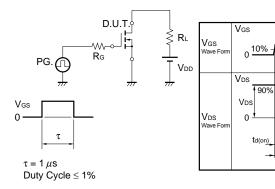
Note Pulsed

# **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

# $V_{GS} = 20 \rightarrow 0 \text{ V}$ $PG. \bigcirc PG. \bigcirc PG.$

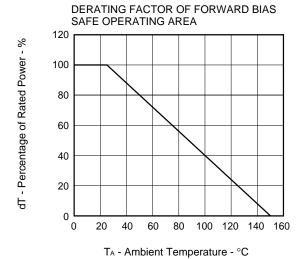


# TEST CIRCUIT 2 SWITCHING TIME

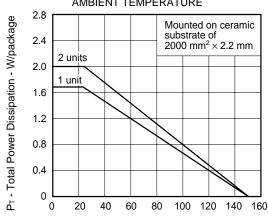


### **TEST CIRCUIT 3 GATE CHARGE**

# TYPICAL CHARACTERISTICS (TA = 25°C)

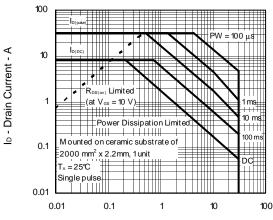


# TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



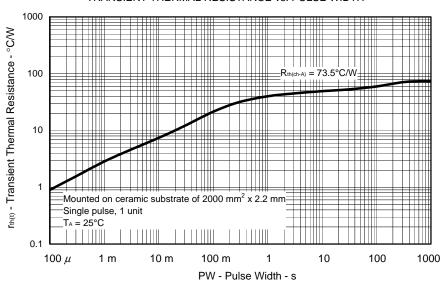
TA - Ambient Temperature - °C

# FORWARD BIAS SAFE OPERATING AREA



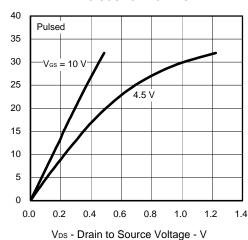
V<sub>DS</sub> - Drain to Source Voltage - V

#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

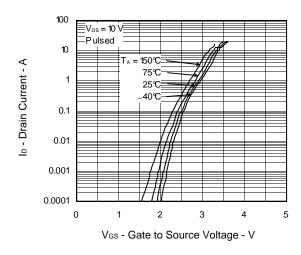


lo - Drain Current - A

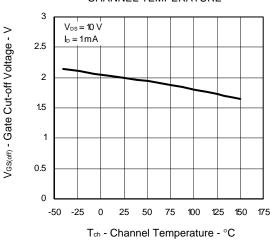
# DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



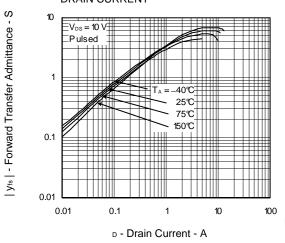
#### FORWARD TRANSFER CHARACTERISTICS



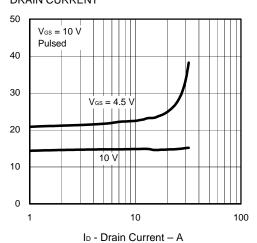
# GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



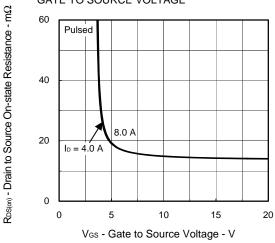
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

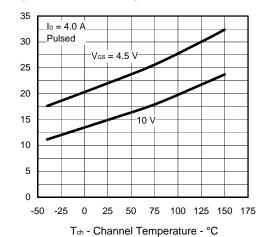


RDS(m) - Drain to Source On-state Resistance - mΩ

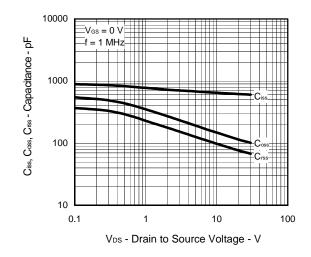
RDS(01) - Drain to Source On-state Resistance - mΩ

IF - Diode Forward Current - A

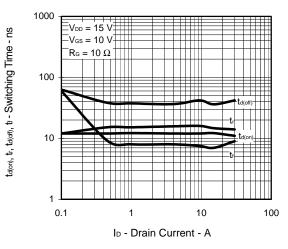
# DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



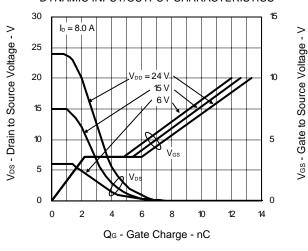
#### CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



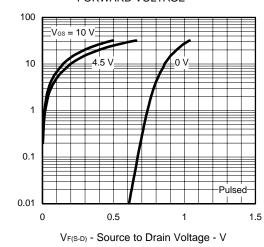
#### SWITCHING CHARACTERISTICS



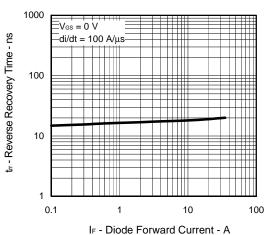
DYNAMIC INPUT/OUTPUT CHARACTERISTICS

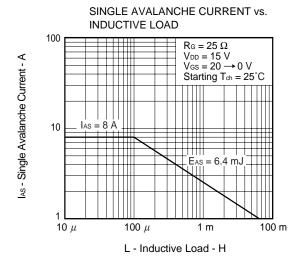


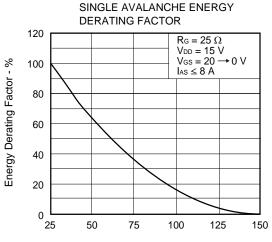
# SOURCE TO DRAIN DIODE FORWARD VOLTAGE



# REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT







Starting Tch - Starting Channel Temperature - °C

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